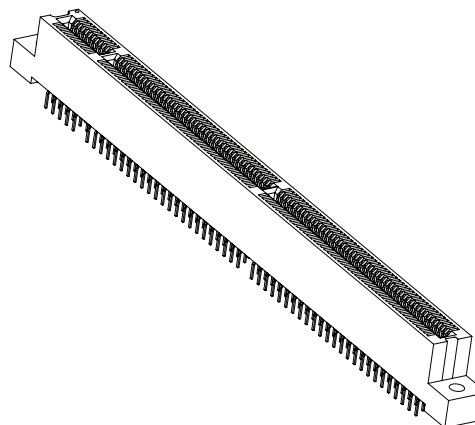


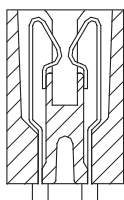


## SPECIFICATIONS

- Accommodates  $.062" \pm .008"$  [1.57 mm  $\pm$  0.20 mm] PC board  
(Consult factory for other board thicknesses)
- PPS or PA9T insulator
- Molded-in key available
- High reliability/high cycle hairpin bellow contacts
- 1 Amp current rating per contact for contacts fully energized
- UL Flammability Rating: 94V-0



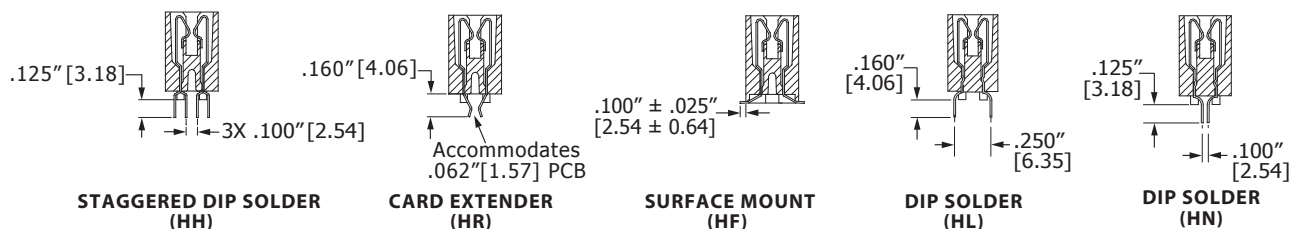
## READOUT



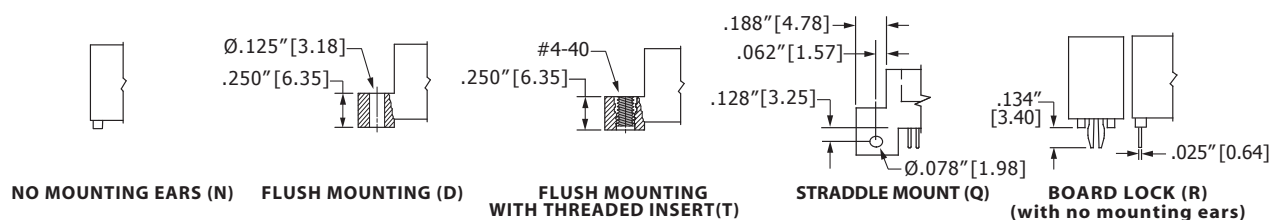
**DUAL (D)**

## TERMINATION TYPE

**Consult Factory for PC Board Layouts**



## MOUNTING STYLE



**.050" [1.27 mm] Contact Centers, .610" [15.49 mm] Insulator Height,  
[MCA] Dip Solder/Card Extender/SMT**

### Industry Standard Part

## PART NUMBER OPTIONS

### MATERIALS (INSULATOR/CONTACT)

G = PA9T/Phosphor Bronze

R = PPS/Phosphor Bronze

J = PA9T/Beryllium Copper

A = PPS/Beryllium Copper

Refer to Page 7 for Operating/Processing Temperatures

**CONTACT FINISH - RoHS Compliant**

**All platings are Lead Free and have .000050" Nickel underplate**

### Contact Surface

## Termination

B = .000010" Gold

.000100" Pure Tin, Matte

C = .000030" Gold

.000100" Pure Tin, Matte

## CONTACT CENTERS

$$B = .050'' [1.27 \text{ mm}]$$

### NUMBER OF CONTACT POSITIONS

56, 66, 91, 106

**G B B 56 D HH D-S578**

— **MODIFICATION** (Consult Factory)

-S578 = Card Slot Barriers With Guide Posts

-S621 = Card Slot Barriers Without Guide Posts

## —MOUNTING STYLE

N = No Mounting

D = Flush Mounting

T = Flush Mounting With Threaded Insert

Q = Straddle Mount

(Card Extender Only - Consult Factory)

R = Metal Board Lock

**—TERMINATION TYPE**

HH = Staggered Dip Solder

HR = Card Extender

HF = Surface Mount

HL = .250" [6.35] X .160" [4.06] Dip Solder

HN = .100" [2.54] X .125" [3.18] Dip Solder

**—READOUT**

D = Dual

**DIMENSIONS** Dimensions in [ ] are in millimeters, all others are in inches.

